

S/N 10/789,882

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner: Dao H. Nguyen

Serial No.: 10/789,882

Group Art Unit: 2818

Filed: February 27, 2004

Docket: 303.673US3

Title: INTEGRATED CIRCUIT AND SEED LAYERS

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
10/929251	August 30, 2004	303.672US2	SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION
10/931541	August 31, 2004	303.648US2	METHODS FOR MAKING INTEGRATED-CIRCUIT WIRING FROM COPPER, SILVER, GOLD, AND OTHER METALS

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicant requests that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

PAUL A. FARRAR

By Applicant's Representatives,

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Date 26 April 2005

By

David R. Cochran

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 26 day of April, 2005.

Name

Signature

27W
RCE

<p>CIPE APR 28 2005 REQUEST FOR CONTINUED EXAMINATION (RCE) TRANSMITTAL</p> <p>Subsection (b) of 35 U.S.C. § 132, effective on May 29, 2000, provides for continued examination of an utility or plant application filed on or after June 8, 1995. See The American Inventors Protection Act of 1999 (AIPA).</p>	Application Number	10/789,882
	Filing Date	February 27, 2004
	First Named Inventor	Paul A. Farrar
	Group Art Unit	2818
	Examiner Name	Dao H. Nguyen
	Attorney Docket Number	303.673US3
	Customer No.	21186

This is a Request for Continued Examination (RCE) under 37 CFR § 1.114 of the above-identified application entitled INTEGRATED CIRCUIT AND SEED LAYERS.

Submission required under 37 C.F.R. § 1.114

1. ☐ Consider the amendment(s)/reply under 37 C.F.R. § 1.116 previously filed on .
2. ☐ Consider the arguments in the Appeal Brief or Reply Brief previously filed on .
3. ☐ An Amendment Under 37 CFR § 1.116 (pages) is enclosed.
4. ☐ A new power of attorney (pages) is enclosed.
5. ☒ An Information Disclosure Statement is enclosed (2 pages).
 - a. 1 Form(s) 1449
 - b. Copies of IDS Citations
6. ☒ A check in the amount of \$790.00 is attached to pay the RCE filing fee required under C.F.R. § 1.17(e).
7. ☒ **The Commissioner is hereby authorized to credit overpayments or charge any fees set forth in 37 CFR §§ 1.16 through 1.18 to Deposit Account No. 19-0743.**
8. ☐ A Petition for Extension of Time in the prior application (pages) is enclosed along with a check in the amount of to pay the extension fee.
9. ☒ Others: A Communication Concerning Related Applications (1 pg.).

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

By: David R. Cochran
Atty: David R. Cochran
Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Attn-Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 26 day of April, 2005.

Tina Kohut
Name

2.4.1
Signature

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